

## **Description**

The AO3416A uses advanced trench technology to provide excellent  $R_{DS(ON)}$ , low gate charge and operation with gate voltages as low as 2.5V. This device is suitable for use as a Battery protection



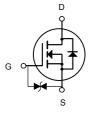
#### **General Features**

 $V_{DS} = 20V I_{D} = 6.5A$ 

 $R_{DS(ON)}$  < 27m $\Omega$  @ V<sub>GS</sub>=4. 5V

or in other Switching application.

ESD=2500HBM



N-Channel MOSFET

## **Application**

Battery protection

Load switch

Uninterruptible power supply

Package Marking and Ordering Information

Product ID	Pack	Marking	Qty(PCS)
AO3416A	SOT23-3L	AGBV 1N	3000

## Absolute Maximum Ratings (T<sub>A</sub>=25℃ unless otherwise noted)

Symbol	Parameter	Limit	Unit	
V <sub>DS</sub>	Drain-Source Voltage	20	V	
Vgs	Gate-Source Voltage	±12	V	
I <sub>D</sub>	Drain Current-Continuous	6.5	А	
Ідм	Drain Current-Pulsed (Note 1)	30	А	
P <sub>D</sub>	Maximum Power Dissipation	1.4	W	
Тл,Тѕтс	Operating Junction and Storage Temperature Range	-55 To 150	°C	
Reja	Thermal Resistance, Junction-to-Ambient (Note 2) 89			



# Electrical Characteristics (T<sub>A</sub>=25°Cunless otherwise noted)

Parameter	Symbol	Condition	Min	Тур	Max	Unit
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	V <sub>GS</sub> =0V I <sub>D</sub> =250µA	20		-	V
Zero Gate Voltage Drain Current	IDSS	V <sub>DS</sub> =20V,V <sub>GS</sub> =0V	-	-	1	μA
Gate-Body Leakage Current	lgss	V <sub>GS</sub> =±10V,V <sub>DS</sub> =0V	-	-	±10	μΑ
Gate Threshold Voltage	VGS(th)	$V_{DS}=V_{GS},I_{D}=250\mu A$	0.45	0.7	1.0	V
		V <sub>GS</sub> =4.5V, I <sub>D</sub> =6.5A	-	17	27	mΩ
Drain-Source On-State Resistance	Rds(on)	V <sub>GS</sub> =2.5V, I <sub>D</sub> =5.5A	-	21	33	mΩ
		V <sub>GS</sub> =1.8V, I <sub>D</sub> =5A	-	28	40	mΩ
Forward Transconductance	grs	V <sub>DS</sub> =5V,I <sub>D</sub> =6.5A	8	-	-	S
Input Capacitance	Clss		-	660	-	PF
Output Capacitance	Coss	$V_{DS}$ =10V, $V_{GS}$ =0V, F=1.0MHz	-	160	-	PF
Reverse Transfer Capacitance	Crss	1 – 1.01VII 12	-	87	-	PF
Turn-on Delay Time	t̄d(on)	V <sub>DD</sub> =10V,R <sub>L</sub> =1. 5Ω	-	0.5		nS
Turn-on Rise Time	tr		-	1		nS
Turn-Off Delay Time	t <sub>d(off)</sub>	$V_{\text{GS}}\text{=}5\text{V}, R_{\text{GEN}}\text{=}3\Omega$	-	12		nS
Turn-Off Fall Time	t <sub>f</sub>		-	4		nS
Total Gate Charge	Qg		-	8		nC
Gate-Source Charge	Q <sub>gs</sub>	Q <sub>gs</sub> V <sub>DS</sub> =10V,I <sub>D</sub> =6.5A, V <sub>GS</sub> =4.5V	-	2.5	-	nC
Gate-Drain Charge	Q <sub>gd</sub>	v GS-4.0 v	-	3	-	nC
Diode Forward Voltage (Note 3)	Vsp	V <sub>GS</sub> =0V,I <sub>S</sub> =6.5A	-	-	1.2	V
Diode Forward Current (Note 2)	Is		-	-	6.5	Α

#### Notes:

Repetitive Rating: Pulse width limited by maximum junction temperature. Surface Mounted on FR4 Board,  $t \leq 10$  sec. Pulse Test: Pulse Width  $\leq 300\mu s$ , Duty Cycle  $\leq 2\%$ . Guaranteed by design, not subject to production



## **Typical Characteristics**

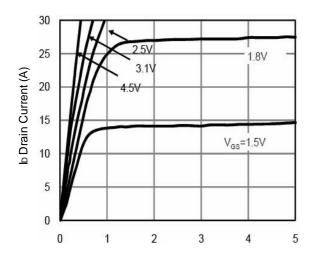


Fig.1 Typical Output Characteristics

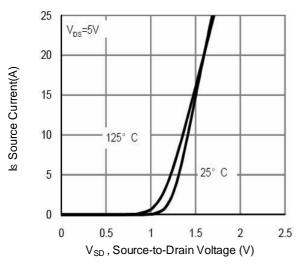


Fig.3 Forward Characteristics of Reverse

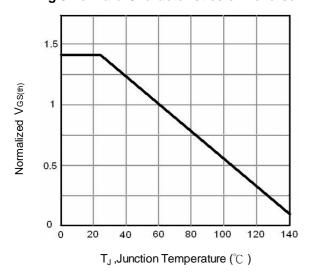


Fig.5 Normalized  $V_{GS(th)}$  vs.  $T_J$ 

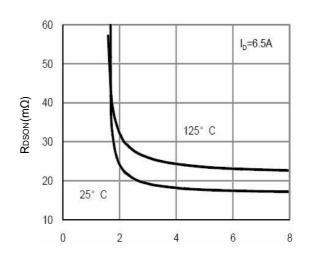


Fig.2 On-Resistance vs. Gate-Source

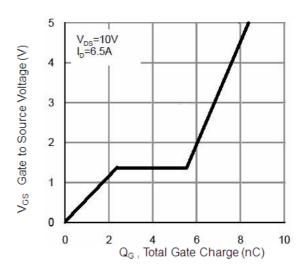


Fig.4 Gate-Charge Characteristics

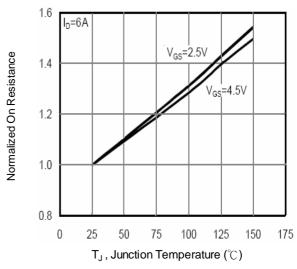
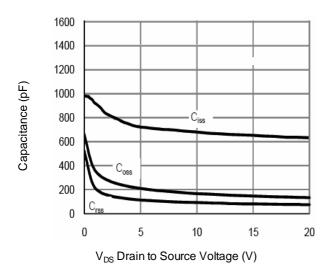


Fig.6 Normalized R<sub>DSON</sub> vs. T<sub>J</sub>





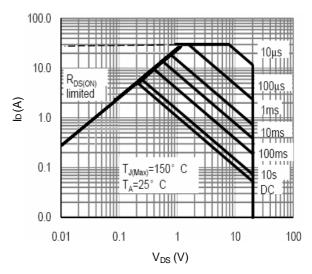
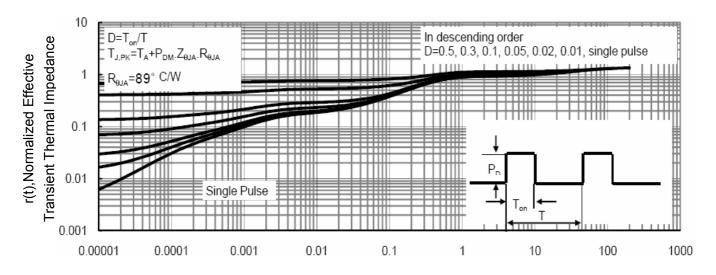
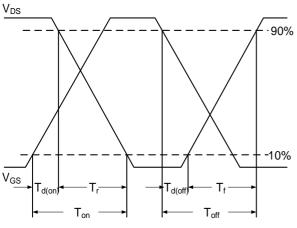


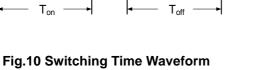
Fig.7 Capacitance

Fig.8 Safe Operating Area



Square Wave Pluse Duration(sec)
Fig.9 Normalized Maximum Transient Thermal Impedance





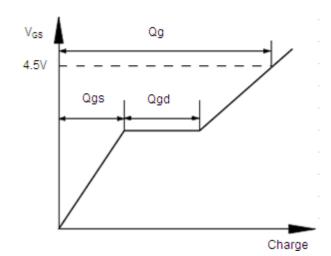
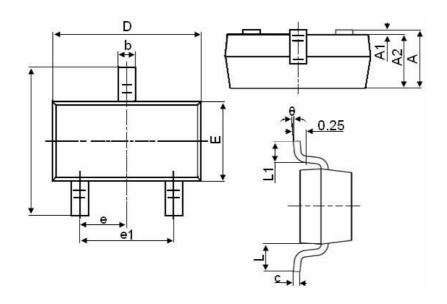


Fig.11 Gate Charge Waveform



# **SOT23-3L Package Information**



Symbol	Dimensions in Millimeters			
	MIN.	MAX.		
А	1.050	1.250		
A1	0.000	0.100		
A2	1.050	1.150		
b	0.300	0.500		
С	0.100	0.200		
D	2.800	3.000		
E	1.500	1.700		
E1	2.650	2.950		
е		0.950TYP		
e1	1.800	2.000		
L		0.550REF		
L1	0.300	0.600		
θ	0°	8°		



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